



Light modulation photo IC

S4282-51, S6809, S6846, S6986, S7136/-10, S10053/-01DT

Fewer detection errors even under disturbance background light

These light modulation photo ICs were developed for optical synchronous detection under disturbance background light. A photodiode, preamplifier, comparator, oscillator, LED driver and signal processing circuit, etc. are all integrated on a monolithic photo IC chip. Optical synchronous type photoreflectors and photointerrupters, which less susceptible to disturbance background light, can be easily configured by just connecting an external LED to this photo IC. Our unique circuit design achieves an allowable background light level of 10000 lx typ. (S4282-51, S6986, S10053/-01DT) and a minimum detection level of 0.2 μ W/mm² typ. (S6809, S6846, S7136/-10).

Features

- Large allowable background light level S4282-51, S6986, S10053/-01DT: 10000 lx typ. S6809, S6846, S7136/-10 : 3000 lx typ.
- Minimum detection level S4282-51, S6986, S10053/-01DT: 0.7 μW/mm² typ. S6809, S6846, S7136/-10 : 0.2 μW/mm² typ.
- Digital output (Output appears "L" by light input.)
- Small hysteresis (S6809)
- Small SMD package S10053: stick S10053-01DT: reel

- Applications

- Paper detection in office machine (copiers, fax machines, etc.)
- Optical switches

Absolute maximum ratings (Ta=25 °C)

Parameter	Symbol	S10053/-01DT	S4282-51, S6986	S6809, S6846, S7136/-10	Unit
Supply voltage	Vcc	-0.5 to +16			V
Output voltage	Vo	-0.5 to +16			V
Output current	Io		50		mA
Cathode output voltage	Vcath		-0.5 to +16		V
Cathode output current	Icath	-	-	70	mA
Power dissipation*1	Р	250			mW
Operating temperature	Topr	-25 to +85 -25 to +60			°C
Storage temperature	Tstg	-40 to +100			°C
Soldering temperature	Tsol	240 (once)*2	*3	*3	°C

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

*1: Power dissipation decreases at a rate of 3.3 mW/°C above Ta=25 °C

*2: Reflow soldering, IPC/JEDEC-J-STD-020 MSL5a, see P.9

*3: See the recommended soldering conditions (P.9).



Directivity



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Electrical and optical characteristics (Ta=25 °C, Vcc=5 V)

Parameter		Symbol		S4282-51, S6986, S10053/-01DT			S6809, S6846, S7136/-10			Unit
			Condition	Output: built-in pull-up resistor* ²			Output: open collector* ³			
				Cathode: constant current drive			Cathode			
				Min.	Typ.	Max.	Min.	Typ.	Max.	
Su	oply voltage	Vcc		4.5	-	16	4.5	-	16	V
Cui	rrent consumption	Icc	Vo, LED terminals open	-	4	11	-	4	11	mA
rt	Low level output voltage	VOL	IoL=16 mA	-	0.2	0.4	-	0.2	0.4	v
Outpi	High loval			4.9	-	-				V
	output voltage	Vон	4.7 kΩ between Vcc and Vo				4.5	-	-	v
athode	Low level output voltage	Vcath	Icath=40 mA			-	-	0.8	v	
	Low level output current	Icath	Vcath=1.2 V	15	35	60				mA
Ü	Pulse cycle	Тр		65	130	220	65	130	220	μs
	Pulse width	Tw		4	8	13.7	4	8	13.7	μs
H—	L threshold light level	Ehl	λ=940 nm No background light	-	0.7	2	-	0.2	1.0	µW/mm ²
Hysteresis							0.45	0.65	0.95	
		-		0.45	0.65	0.95	0.65 (S6809)	0.8 (S6809)	0.95 (S6809)] -
Fre	quency response	f		0.5	1.25	-	0.5	1.25	-	kHz
Allowable background light level		Ex	Signal light: 5 μW/mm², λp=940 nm Background light: "A" light source	5000	10000	-	2000	3000	-	lx









*3: Cathode







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Block diagram and internal functions



Truth table

Input	Output level
Light on	low
Light off	high

(a) Oscillator and timing signal generator

The oscillator produces a reference oscillation output by charging and discharging the built-in capacitor with constant current. The oscillation output is fed to the timing signal generator, which then creates LED drive pulses and various timing pulses for digital signal processing.

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(b) LED driver circuit

This circuit drives an external LED using the LED drive pulses created by the timing signal generator. The duty cycle is 1/16. (c) Photodiode and preamplifier circuit

The photodiode is formed on the same monolithic chip. A photocurrent generated in the photodiode is converted to a voltage by a preamplifier circuit. The preamplifier circuit uses an AC amplifier to expand the dynamic range versus DC or low-frequency background light, without impairing signal detection sensitivity.

(d) Capacitive coupling, buffer amplifier and reference voltage generator Capacitive coupling removes low-frequency noise and also cancels the DC offset in the preamplifier. The buffer amplifier boosts the signal up to the comparator level, and the reference voltage generator produces a comparator level voltage.

(e) Comparator circuit

The comparator circuit has a hysteresis function to prevent chattering caused by small fluctuations in the input light.

(f) Signal processing circuit

The signal processing circuit consists of a gate circuit and digital integrator circuit. The gate circuit discriminates input pulses during synchronous detection, to prevent operational errors caused by asynchronous background light. Background light which is synchronized with the signal detection timing cannot be eliminated by the gate circuit, but is canceled out by the digital integrator circuit at the latter stage.

(g) Output circuit

This circuit serves as an output buffer for the signal processing circuit and outputs the signal to an external circuit.



Dimensional outlines (unit: mm)







S7136-10

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Recommended land patterns (unit: mm)





Reel packing specifications (S10053-01DT)

Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
φ254 mm	ф80 mm	12 mm	PS	Antistatic treatment

Embossed tape (unit: mm, material: PS, electrically conductive)





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- Packing quantity 2000 pcs/reel
- Packing type

Reel and desiccant in moisture-proof packaging (vacuum-sealed)



Recommended soldering conditions

S4282-51, S6809, S6846, S6986, S7136/-10				
Type No.	Solder temperature	Remarks		
S4282-51		at least 1 mm away from lead roots*6		
S6809, S6846, S6986	230 °C (less than 5 s) max.	at least 1.8 mm away from lead roots*6		
S7136		at least 1 mm away from lead roots*6		
S7136-10	*7	-		

*6: Lead length: in case of 2 mm or more

*7: Contact us for detailed information.

Note: When setting the soldering conditions, check for any problems by testing out the soldering methods in advance.

S10053/-01DT

The S10053/-01DT supports lead-free soldering. After unpacking, store it in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform soldering within 24 hours.



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Note: The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When setting the reflow soldering conditions, check for any problems by testing out the reflow soldering methods in advance.



Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- Disclaimer
- · Metal, ceramic, plastic package products
- Surface mount type products

Information described in this material is current as of August 2021.

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